Attorney Docket No. MEMC 98-4900	· · · · · ·			
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To the Honorable Commissi	ioner o:	101395065	riginal documen	t(s) or copy thereof.
1. Name of conveying party(ies) (assignor(s))				
Robert J. Falster and Vladimer Voron	nkov			i i
Additional name(s) of conveying party(ies)	attached? 🗆 ves 🏿 🗷	I no		S 25
Name and Address of Party(ies) receiving a	an interest (assignee(s))):		GPR/FIN
Name: MEMC Electronic Materials, Inc	չ			
Address. 301 Pearl Drive				
City City Dist	· · · · · · · · · · · · · · · · · · ·			
State: Missouri Zip: Country:	63376			- 0
				-
Additional name(s) & address(es) attached? Nature of Conveyance:	□ yes ⊠ no			
	Merger	☐ Change of Name		
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	Security Agreement			NT
Execution Date: May 8, 2000 and M	ay 10, 2000			
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PATENT REEL: 010883 FRAME: 0216

CONFIRMATORY ASSIGNMENT

WHEREAS, WE, Robert J. Falster of London, England and Vladimer Voronkov of Milano, Italy, by an assignment fully executed on November 29, 1999 (recorded December 27, 1999; reel/frame: 010481/0004; a copy of which is attached hereto as Exhibit A) intended to transfer to MEMC Electronic Materials, Inc. of St. Peters, Missouri, a corporation of the State of Delaware (hereinafter referred to as the "Assignee"), a onethird interest each of all right, title and interest in and to an invention for an improvement relating to a PROCESS FOR PREPARING DEFECT FREE SILICON CRYSTALS WHICH ALLOWS FOR VARIABILITY IN PROCESS CONDITIONS and an application for a United States patent based thereon, now assigned Serial No. 09/344,036 (hereinafter "said United States application"), and any and all Letters Patent (including extensions thereof) of any country which may be granted on any of the said United States application or said invention or any part thereof (hereinafter "said Letters Patent");

and whereas, through a scrivener's error, the entire right, title and interest in the application and any other application based in whole or in part thereon were assigned, rather than our one-third interest each of the entire right, title and interest;

NOW, THEREFORE, in order to correct these errors, we do hereby confirm that by the attached Exhibit A assignment, for and in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration recited in the attached Exhibit A assignment, the receipt of all of which is hereby acknowledged, we intended to transfer our one-third interest

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each of the entire right, title and interest in and to the invention disclosed in said United States application and in and to said United States application and said Letters Patent. to said Assignee, and to the extent that the attached Exhibit A assignment was ineffective in doing so, we, Robert J. Falster and Vladimer Voronkov (hereinafter referred to as Assignors) hereby sell, assign and transfer unto Assignee, its successors and assigns, all of Assignors' right, title and interest in and throughout the United States of America (including dependencies) and all territories and countries in and to said invention, said United States application, any other United States applications (including divisional, continuing or reissue applications) based in whole or in part on said United States application or in whole or in part on said invention, any foreign applications based in whole or in part on any of the said United States application or in whole or in part on said invention, and any and all patents (including extensions thereof) of any country which have been or may be granted on any of the aforesaid applications or on said invention or any part thereof;

TO BE HELD AND ENJOYED BY Assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by Assignors had this sale and assignment not been made;

AND be it known that Assignors hereby authorize and request the Commissioner of Patents of the United States of America to issue any and all United States patents which may be granted upon said United States applications or any of them, or upon said invention or any part thereof, to said Assignee;

AND Assignors hereby jointly and severally agree for Assignors and for Assignors' respective heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said Assignee fully to secure to said Assignee its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

AND Assignors hereby jointly and severally covenant for Assignors and Assignors' respective legal representatives that Assignors have granted no right or license to make, use or sell said invention to anyone except said Assignee, that prior to the execution of this deed our right, title and interest in said invention has not been otherwise encumbered, and that Assignors have not executed and will not execute any instrument in conflict herewith;

AND Assignors hereby further jointly and severally covenant and agree not to contest the validity of this Assignment or the validity of any Patent or reissue Patent to issue for the invention from any patent application or continuation thereof to which this Assignment relates.

THIS is a nunc pro tunc assignment and shall be considered to have been made as of the 29th day of November, 1999.

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IN WITNESS WHE	REOF, we ha	Witness Witness	8/5/65 Date 8/5/60 Date
Vladimer Voronkov	 Date	Witness	Date

Witness

Date

IN WITNESS WHEREOF, we have hereunto set our hands.

Robert J. Falster

	ACKNOWLEDGEMENT	
STATE OF)	
On this	, day of, 2 , a Notary Public, pe	000, before me, rsonally appeared
Robert J. Falster to who executed the fo	to me known to be the person oregoing assignment and ack	described in and
	MONY WHEREOF, I have hereun year last above written.	to set my hand and
	Notary Public	
y Commission Expires:		
Symb 18.03 Tadimer Voronkov Dat	i.2000 ed felis Withesa Houts	
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	To the Honorable Commissione.	1244267	ed original document(s) or copy thereoi.
7	Name of conveying party(ies) (assignor(s)):		DP EC C
7	Robert J. FALSTER, Vladimer VORONKOV	CEIN C 27 R/FIN	
12/2	Additional name(s) of conveying party(ies) attached? ves 2. Name and Address of Party(ies) receiving an interest (assignee(s		CEIVED EC 27 PM 2: R/FINANCE
Ş	Name: MEMC Electronic Materials, Inc. Address: 501 Pearl Drive P. O. Box 8		<u> </u>
V	City St. Peters		
1/1/	State: Missour Zip: 63376 Country: U.S.A.		
	Additional name(s) & address(es) attached? ves no		
	☑ Assignment ☐ Merger	☐ Change of Name	
	☐ Verified Translation ☐ Security Agreement	Other	
	Execution Date: November 29, 1999		-
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	Edward J. Hejlek		1)
I	Senniger, Powers, Leavitt & Roedel	☑ Enclosed	
ı	One Metropolitan Square 16th Floor		charged to deposit account
ı	St. Louis, Missouri 63102 (314) 231-5400 (telephone)	Deposit Account Number Duplicate copy of the	
01.4	3/2000 DCOATES 00000017 09344036	Charge any underpo above Deposit Accor	tyment or credit any overpayment to
01	-C:581 40.00 OP	O NOT USE THIS SPACE	uiii
-	Statement and signature		
ı	To the best of my knowledge and belief, the foregoing information	is true and correct and any attack	hed copy is a true copy of the original document.
	Edward J. Hetlek	(L) 12,	122/29
	Name of Person Signing Signi	ature Date Cluding cover sheet, attachments.	and document
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PATENT REEL: 010883 FRAME: 0222

ASSIGNMENT

WHEREAS, We Robert Falster of Milan, Italy and Vladimer Voronkov of Milano, Italy, have invented an improvement in PROCESS FOR PREPARING DEFECT FREE SILICON CRYSTALS WHICH ALLOWS FOR VARIABILITY IN PROCESS CONDITIONS (File MEMC 98-4900(2458)) and have executed an application for a United States patent based thereon Serial No. 09/344,036, filed June 25, 1999;

AND, WHEREAS, MEMC Electronic Materials, Inc. of St. Peters, Missouri, a corporation of the State of Delaware (hereinafter referred to as "ASSIGNEE") is desirous of acquiring certain rights thereunder;

NOW, THEREFORE, for one dollar and other good and valuable consideration, receipt of all of which is hereby acknowledged, we have agreed to and do hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto in and to said invention, said United States application, any other United States applications (including divisional, continuing or reissue applications) based in whole or in part on said United States application or in whole or in part on said invention, any foreign applications based in whole or in part on any of the aforesaid United States application or in whole or in part on any of the aforesaid United States application or in whole or in part on said invention, and any and all patents (including extensions thereof) of any country

7.

PATENT REEL: 010883 FRAME: 0223 which have been or may be granted on any of the aforesaid applications or on said invention or any part thereof;

TO BE HELD AND ENJOYED by said ASSIGNEE, its successor and assigns, as fully and entirely as the same would have been held and enjoyed by us had no sale and assignment of said interest been made;

AND We hereby authorize and request the Commissioner Patents of the United States of America to issue any and all United States patents which may be granted upon said United States applications or any of them, or upon said invention or any part thereof, to said ASSIGNEE;

and for our respective heirs, executors and administrators, t execute without further consideration any further lawful documents and any further assurances, and any divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said ASSIGNEE fully to secure to said ASSIGNEE its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

AND We hereby jointly and severally covenant for ourselves and our respective legal representatives that we have granted no right or license to make, use or sell said invention, to anyone except said ASSIGNEE, that prior to the execution of this deed our right, title and interest in said invention had not been otherwise encumbered, and that we have

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not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, we have hereunto set our hands.

29/11/99

Robert Falster

WITNESS: John Mulh 29/11/99

WITNESS: John Mulh 29/11/99

WITNESS: John Mulh 29/11/99

Rodo Collecte 29/11